



Docket No.: M4065.0239/P239
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Larry Hillyer et al.

Application No.: 09/653,561

Art Unit: 2812

Filed: August 31, 2000

Examiner: Ha T. Nguyen

For: METHOD AND MATERIAL FOR
REMOVING ETCH RESIDUE FROM HIGH
ASPECT RATIO CONTACT SURFACES

AMENDMENT TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action mailed June 6, 2005, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 17 of this paper.